

ICN2053

(16-Channel PWM Constant Current LED Sink Driver)

#### **Description**

The ICN2053 is a 16-channel PWM constant current sink LED driver for 1:32 time multiplexing applications. The constant-current value of all 16 channels is set by a single external resistor.

ICN2053 converts serial input date into the gray scale of each pixel by a 16-bit shift register.ICN2053 detects individual LED open errors without extra components. ICN2053 also integrated pre-charge circuit for ghosting reduction.

The ICN2053 exploits precise current regulation technology, with both channel-to-channel error and chip-to-chip error less than  $\pm 2.0\%$ .

#### **Features**

- 4 16 constant-current output channels
- ♦ Support time-multiplexing for 1~32 scans
- ♦ Output current setting range: 0.5~25mA×16@V<sub>DD</sub>=5V constant current output 0.5~18mA×16@V<sub>DD</sub>=4.2V constant current output 0.5~10mA×16@V<sub>DD</sub>=3.3V constant current output
- ♦ Current accuracy

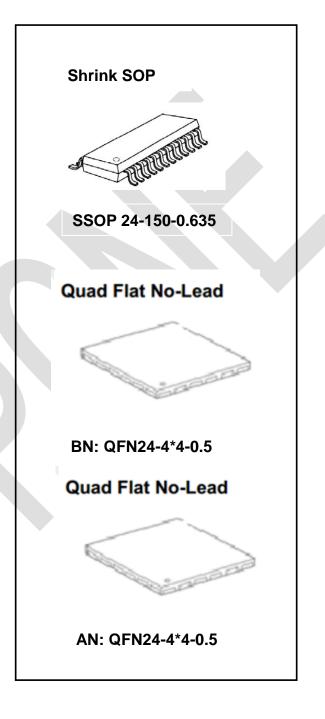
Between channel :<  $\pm 2.0$  %(Max.) Between ICs :<  $\pm 2.0$  % (Max.)

- ♦ 8 bit current gain: 12.5%~200%
- ♦ Fast response of output current:  $\overline{OE}$  (min):20ns@V<sub>DD</sub>=5V
- ♦ Data transfer frequency: f<sub>MAX</sub>=35MHz(Max)
- ♦ Power supply voltage:  $V_{DD}=3.3\sim5V$
- ♦ Operating Temperature: -40°C to +85°C
- ♦ Output current equation

$$Iout = \frac{9.2}{R}$$

- $\Rightarrow \quad \text{Pre-charge for ghosting reduction}$
- ♦ LED open detection
- Enhanced Circuit for Caterpillar Cancelling
- ♦ Low-gray scale enhancement
- ♦ Integrating LED protection circuit

#### Package

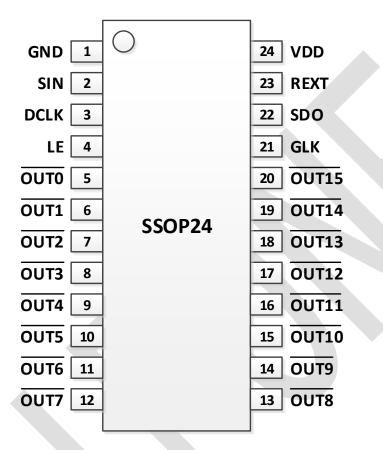


ICN2053



#### **Pin Configuration**

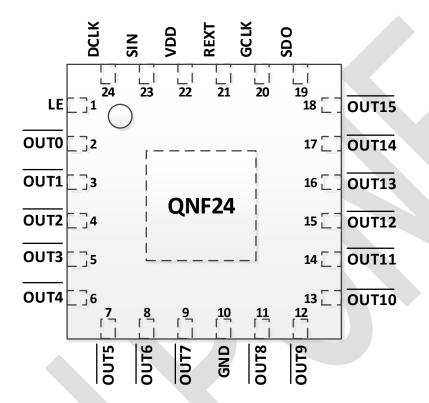
1 BP:SSOP24-P-150-0.635



ICN2053(SSOP24)				
Pin No.	Pin Name	Function		
1	GND	Power Ground		
2	SIN	Serial data input		
3	DCLK	Clock input terminal for data shift and command information		
4	Ľ	Data transfer command input		
5~20	$\overline{\text{OUT0}} \sim \overline{\text{OUT15}}$	Constant current output		
21	GCLK	The reference clock input pin for PWM gray scale control		
22	SDO	Serial data output		
23	REXT	Constant-current value setting .Connection to an external resistor to GND		
24	VDD	Power-supply voltage		



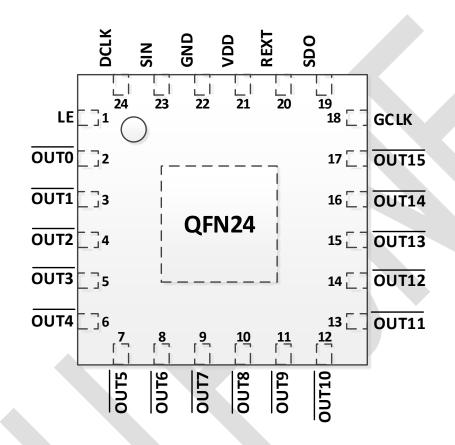
2 BN: QFN24-4\*4-0.5



ICN2053BN(QFN24)						
Pin No.	Pin No. Pin Name Function					
1	LE	Data transfer command input				
2~9,11~18	$\overline{\text{OUT0}} \sim \overline{\text{OUT15}}$	Constant current output				
10	GND	Power Ground				
19	SDO	Serial data output				
20	GCLK	The reference clock input pin for PWM gray scale control				
21	REXT	Constant-current value setting .Connection to an external resistor to GND				
22	VDD	Power-supply voltage				
23	SIN	Serial data input				
24	DCLK	Clock input terminal for data shift and command information				



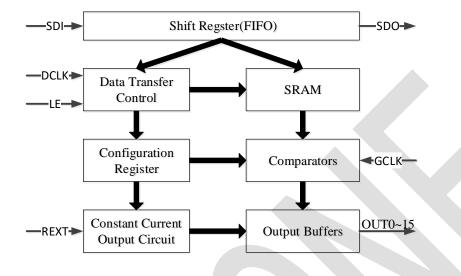
3 AN: QFN24-4\*4-0.5



ICN2053AN(QFN24)				
Pin No.	Pin Name	Function		
1	L	Data transfer command input		
2~17	$\overline{\text{OUT0}} \sim \overline{\text{OUT15}}$	Constant current output		
18	GCLK	The reference clock input pin for PWM gray scale control		
19	SDO	Serial data output		
20	REXT	Constant-current value setting .Connection to an external resistor to GND		
21	VDD	Power-supply voltage		
22	GND	Power Ground		
23	SIN	Serial data input		
24	DCLK	Clock input terminal for data shift and command information		

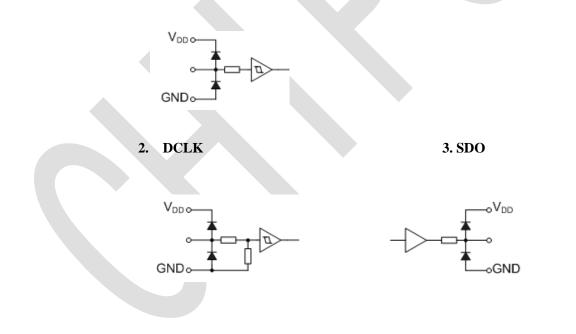


## ICN2053 Block Diagram



**I/O Equivalent Circuits** 

1. GCLK, SDI, LE



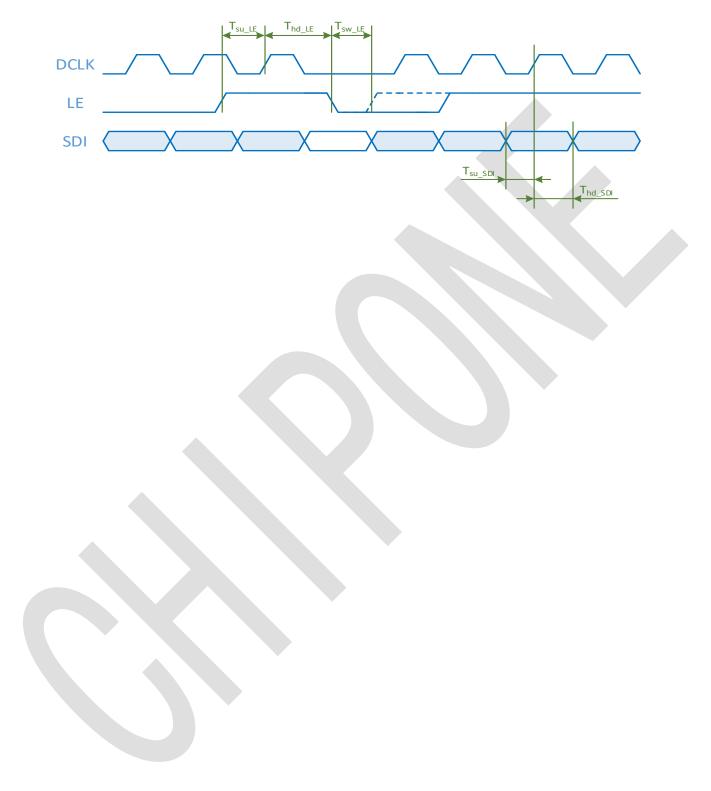
#### **Control Command**

Command Name	Number of DCLK Rising Edge when LE is High	Description	
DATA_LATCH	1	Transfer Serial data to buffers	
WR_DBG	2	Write Debug Register	
VSYNC	3	Vertical Synchronal signal	
WR_CFG1	4	Write Configuration Register 1	
RD_CFG1	5	Read Configuration Register 1	
WR_CFG2	6	Write Configuration Register 2	
RD_CFG2	7	Read Configuration Register 2	
WR_CFG3	8	Write Configuration Register 3	
RD_CFG3	9	Read Configuration Register 3	
WR_CFG4	10	Write Configuration Register 4	
RD_CFG4	11	Read Configuration Register 4	
EN_OP	12	Enable All Output Channels	
DIS_OP	13	Disable All Output Channels	
PRE_ACT	14	Pre-Active command	

## Data Transfer Order

Line	Channel				
	Channel 15 (OUT15)				
Lino 1	Channel 14 (OUT14)				
Line					
	Channel 0 (OUT0)				
	Channel 15 (OUT15)				
Line 2	Channel 14 (OUT14)				
	Channel 0 (OUT0)				
	Channel 15 (OUT15)				
Line 22	Channel 14 (OUT14)				
	Channel 0 (OUT0)				
	Line 1 Line 2 				

## **Timing Diagram**



## Maximum Rating (Ta=25°C)

Characteristics		Symbol	Rating	Unit
Supply Voltage		V <sub>DD</sub>	0~6.0	V
Output Current		lo	25	mA
Input Voltage		Vin	-0.4~V <sub>DD</sub> +0.4	V
Output voltage	Output voltage		11V	
Clock Frequency		Fс∟к	35	MHz
GND Terminal Current	GND Terminal Current		+1000	mA
Power Dissipation (On PCB,25℃)	DN-type	P <sub>D</sub>	3.19	W
Thermal Resistance DN-type		Rth(j-a)	39.15	°C/W
Operating Temperature		T <sub>opr</sub>	-40 ~ 85	°C
Storage Temperature		Tstg	-55 ~ 150	°C

## **Electrical Characteristics** (Unless otherwise specified, V<sub>DD</sub> =4.5~5.5V, T<sub>a</sub> =25°C)

Characteristics	Symbol	Test circuit	Test Conditions	Min	Тур	Max	Unit
High level logic output voltage	Vон	1	Іон=-1mA, SDO	V <sub>DD</sub> -0.4	-	Vdd	V
Low level logic output voltage	Vol	1	Іон=+1mA, SDO	-	-	0.4	V
High level logic input voltage	Vih		0.7*V <sub>DD</sub>	-	Vdd	V	
Low level logic input voltage	Vil	3	GND	-	0.3*V <sub>DD</sub>	V	
High level logic input current	Ьн	2	V <sub>IN</sub> =V <sub>DD</sub> , SDI,CLK,LE,GCLK	-	-	1	μA
Low level logic input current	In	1	V <sub>IN</sub> =GND SDI,CLK,LE,GCLK	-1	-	-	μA
Dower cupply ourrent	IDD1	4	Rext=Open, Out off	-	4.5	6.0	mA
Power supply current	I <sub>DD2</sub>	4	Rext=1.24KΩ, Out off	-	6.0	7.0	mA
Constant current error	Δlo	5	0.5mA~25mA	-	±1.0	±2.0	%
			V <sub>DD</sub> =4.5~5.5V, ,				
Constant current power supply	%V <sub>DD</sub>	5	R <sub>EXT</sub> =3kΩ,	-	±0.1	-	%/V
voltage regulation			$\overline{\text{OUT0}} \sim \overline{\text{OUT15}}$				
			Vo=0.6~3.0V,				
Constant current output voltage	%Vout	5	R <sub>EXT</sub> =3kΩ,	-	±0.1		%/V
regulation			$\overline{\text{OUT0}} \sim \overline{\text{OUT15}}$				
Pull-down resistor	RDOWN	2	DCLK	100	200	400	kΩ

 $V_{DD} = 4.5 \sim 5.5 V$ 

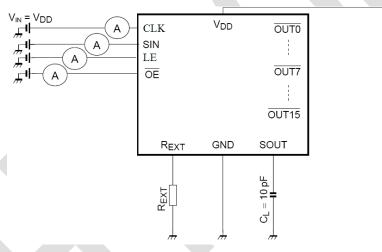
V<sub>DD</sub> = 4.5~5.5 V

## **Test Circuit**

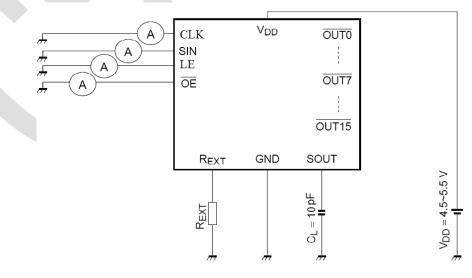
VDD CLK OUTO SIN F.G LE OUT7 OE OUT15  $\begin{array}{l} V_{IH} = V_{DD} \\ V_{IL} = 0 \ V \end{array}$ GND SOUT REXT  $t_r = t_f = 10 \text{ ns}$ (10~90%) REXT l<sub>O</sub> = -1mA~1mA ↑ 10 pF V ວັ

Test Circuit1: High level logic input voltage/Low level logic input voltage

Test Circuit2: High level logic input current/Pull-down resistor

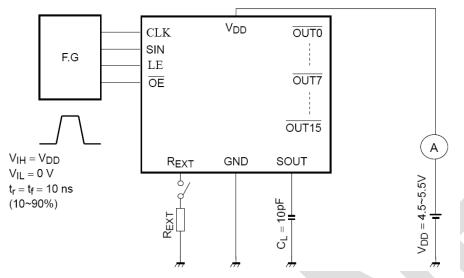


Test Circuit3: Low level logic input current/Pull-up resistor

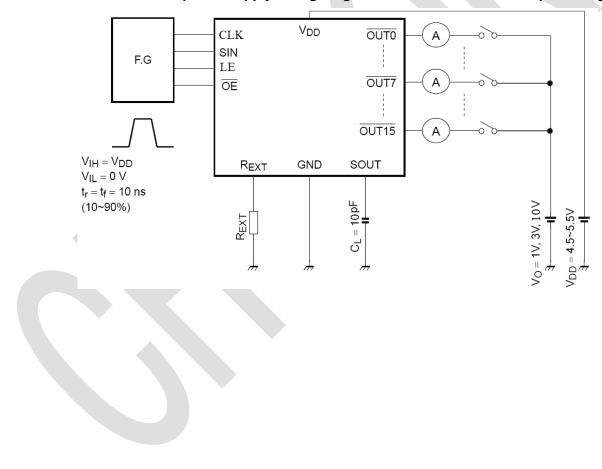




#### Test Circuit4: Power supply current



#### Test Circuit5: Constant current output/Output OFF leak current/Constant current error Constant current power supply voltage regulation/Constant current output voltage regulation

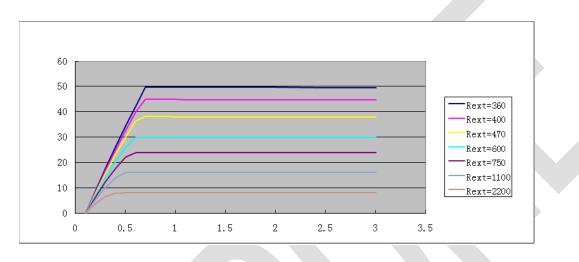


## **Application Information**

ICN2053 exploits precise current regulation technology, providing small channel-to-channel and IC-to-IC current variations.

1) The maximum current variation between channels is less than  $\pm 2.0\%$ , and that between ICs< $\pm 2.0\%$ .

2) The current characteristic of output stage is flat. The output current can be kept constant regardless of the variations of LED forward voltage.



## **Setting Output Current**

The output current (Iout) of ICN2053 is set by an external resistor, Rext. The relationship between Iout and Rext is :

 $V_{R-EXT}$ =1.232V, Igain(default)=200%

 $Iout=(V_{R-EXT}/Rext)*7.5$ 

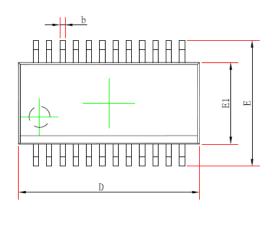
It is recommended that customers use the default value of  $V_{R-EXT} = 2.464V$  for calculation.

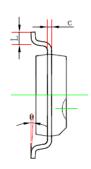


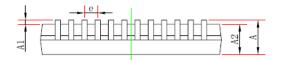
## Package Outline

(1) SSOP24-P-150-0. 635

#### SSOP24 (150mil) PACKAGE OUTLINE DIMENSIONS







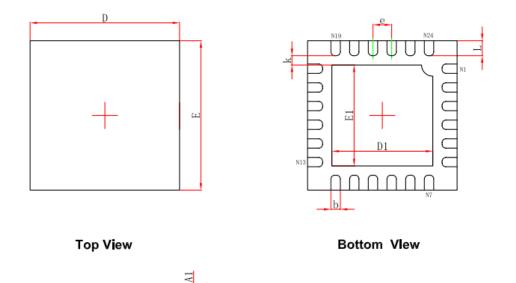
Symbol	Dimensions In	Millimeters	Dimensions In Inches		
Symoor	Min	Max	Min	Max	
А		1.750		0.069	
A1	0.100	0.250	0.004	0.010	
A2	1.250		0.049		
b	0.203	0.305	0.008	0.012	
с	0.102	0.254	0.004	0.010	
D	8.450	8.850	0.333	0.348	
E1	3.800	4.000	0.150	0.157	
Е	5.800	6.200	0.228	0.244	
e	0.635(BSC)		0.025	(BSC)	
L	0.400	1.270	0.016	0.050	
θ	0 °	8°	0 °	8°	



(2) QFN24-4\*4-0.5

QFNWB4×4-24L(PO.50T0.75/0.85) PACKAGE OUTLINE DIMENSIONS

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Symbol	Dimensions I	n Millimeters	Dimensions In Inches		
Symbol	Min.	Max.	Min.	Max.	
A	0.700/0.800	0.800/0.900	0.028/0.031	0.031/0.035	
A1	0.000	0.050	0.000	0.002	
A3	0.203	REF.	0.008	REF.	
D	3.924	4.076	0.154	0.160	
E	3.924	4.076	0.154	0.160	
D1	2.600	2.800	0.102	0.110	
E1	2.600	2.800	0.102	0.110	
k	0.200MIN.		300.0	3MIN.	
b	0.200	0.300	0.008	0.012	
е	0.500TYP.		0.020	TYP.	
L	0.324	0.476	0.013	0.019	

# **Product Ordering Information**

Product number	Package (Pb-Free)	Weight (mg)
I CN2053BP	SS0P24-0. 635	130
I CN2053BN	QFN24-4*4-0.5	38
I CN2053AN	QFN24-4*4-0.5	38

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